

## 20N65-HC

Preliminary

Power MOSFET

20A, 650V N-CHANNEL  
POWER MOSFET

## ■ DESCRIPTION

The UTC **20N65-HC** is a N-channel enhancement MOSFET using UTC's advanced technology to provide the customers with perfect  $R_{DS(ON)}$ , high switching speed, high current capacity and low gate charge.

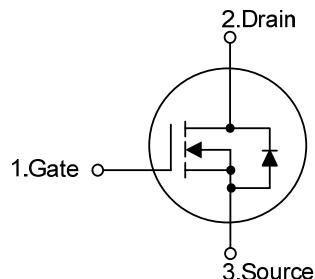
The UTC **20N65-HC** is universally applied in low voltage such as automotive, high efficiency switching for AC/DC converters and DC motor control, etc.

## ■ FEATURES

\*  $R_{DS(ON)} \leq 0.4 \Omega$  @  $V_{GS}=10V$ ,  $I_D=10A$

\* High Switching Speed

## ■ SYMBOL



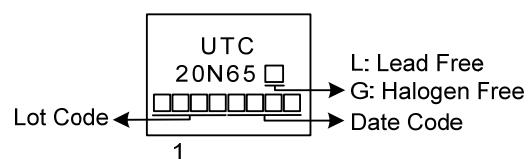
## ■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
20N65L-TF1-T	20N65G-TF1-T	TO-220F1	G	D	S	Tube
20N65L-TF2-T	20N65G-TF2-T	TO-220F2	G	D	S	Tube
20N65L-TF3T-T	20N65G-TF3T-T	TO-220F3	G	D	S	Tube
20N65L-T47-T	20N65G-T47-T	TO-247	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

20N65G-T47-T 	(1) T: Tube (2) TF1: TO-220F1, TF2: TO-220F2, TF3T: TO-220F3, T47: TO-247 (3) G: Halogen Free and Lead Free, L: Lead Free
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## ■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	650	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Continuous Drain Current	Continuous	$I_D$	20	A
	Pulsed	$I_{DM}$	40	A
Single Pulsed Avalanche Energy (Note 3)		$E_{AS}$	1242	mJ
Power Dissipation	TO-220F1/TO-220F2 TO-220F3 TO-247	$P_D$	44	W
Junction Temperature			320	W
Storage Temperature			+150	$^\circ\text{C}$
		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. L=30mH,  $I_{AS}=9.1\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220F1/TO-220F2	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-220F3		40	$^\circ\text{C/W}$
	TO-247			
Junction to Case	TO-220F1/TO-220F2	$\theta_{JC}$	2.84	$^\circ\text{C/W}$
	TO-220F3		0.39	$^\circ\text{C/W}$
	TO-247			

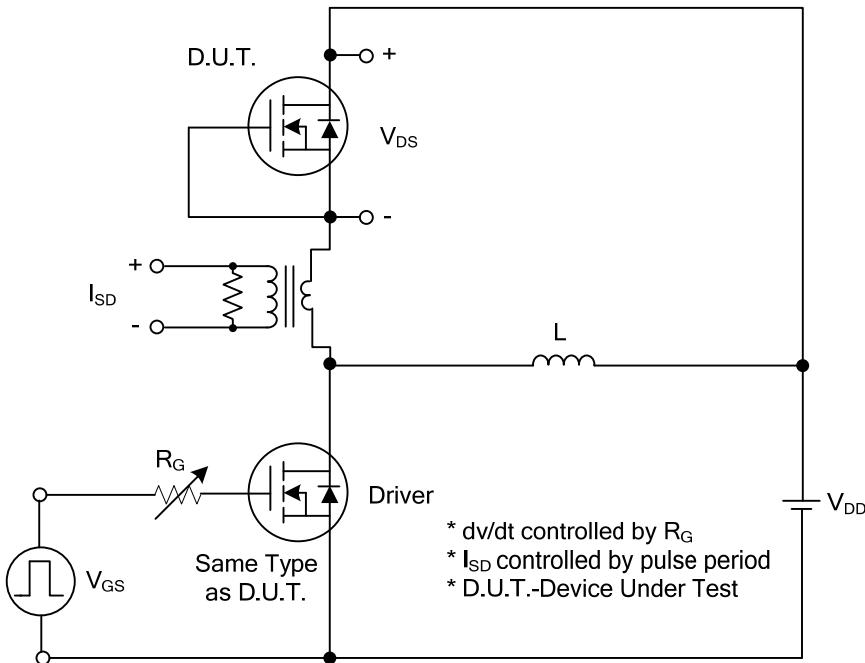
■ ELECTRICAL CHARACTERISTICS ( $T_J=25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	650			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{DS}=650\text{V}, V_{GS}=0\text{V}$		10		$\mu\text{A}$
Gate-Source Leakage Current	Forward $I_{\text{GSS}}$	$V_{GS}=+30\text{V}, V_{DS}=0\text{V}$			+100	nA
	Reverse $I_{\text{GSS}}$	$V_{GS}=-30\text{V}, V_{DS}=0\text{V}$			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=10\text{A}$			0.4	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$		3320		pF
Output Capacitance	$C_{\text{OSS}}$			300		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			22		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge	$Q_G$	$V_{DS}=400\text{V}, V_{GS}=10\text{V}, I_D=20\text{A}$ $I_G=1\text{mA}$ (Note 1, 2)		80		nC
Gate to Source Charge	$Q_{GS}$			22		nC
Gate to Drain Charge	$Q_{GD}$			23		nC
Turn-ON Delay Time	$t_{D(\text{ON})}$	$V_{DD}=100\text{V}, V_{GS}=10\text{V}, I_D=20\text{A},$ $R_G=25\Omega$ (Note 1, 2)		44		ns
Rise Time	$t_R$			31		ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$			245		ns
Fall-Time	$t_F$			72		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				20	A
Maximum Body-Diode Pulsed Current	$I_{SM}$				40	A
Drain-Source Diode Forward Voltage	$V_{SD}$	$I_S=20\text{A}, V_{GS}=0\text{V}$			1.4	V

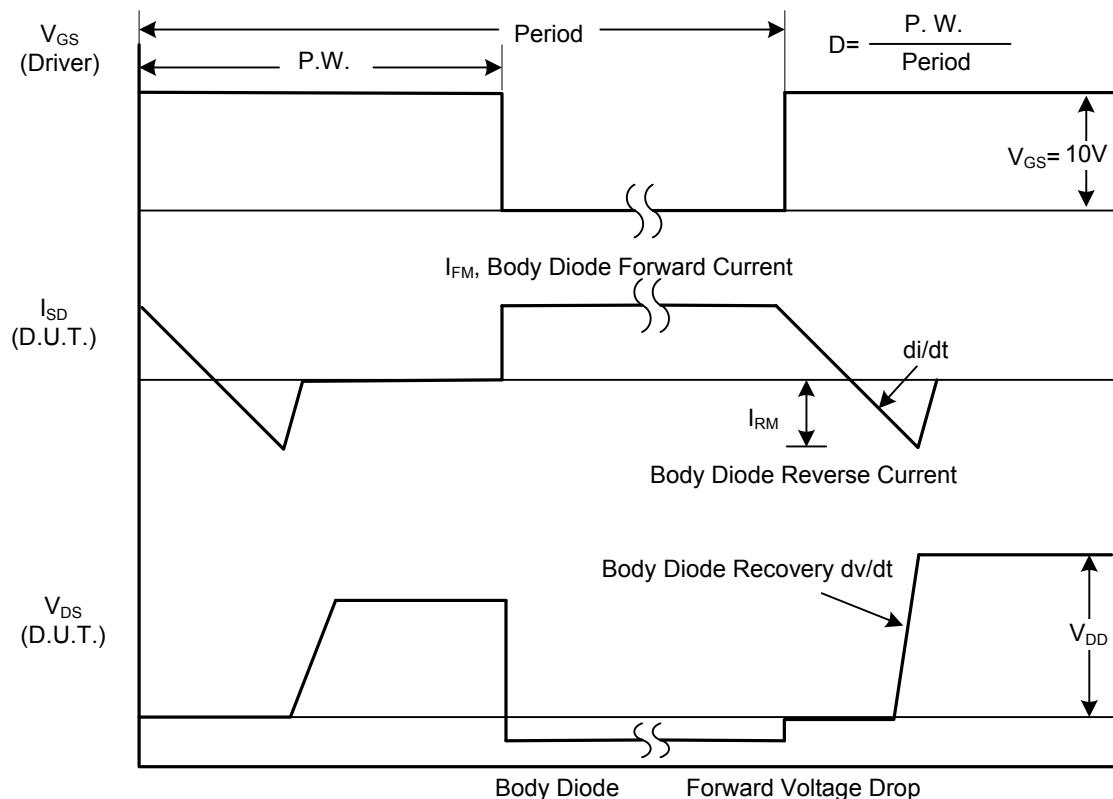
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

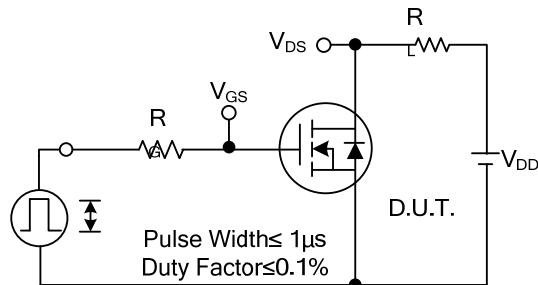


Peak Diode Recovery dv/dt Test Circuit

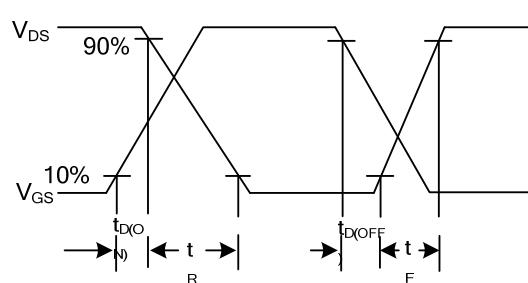


Peak Diode Recovery dv/dt Waveforms

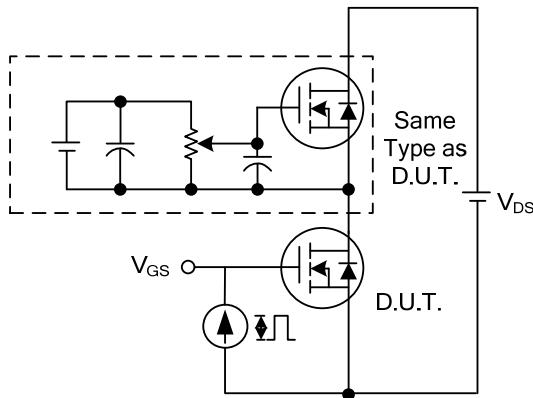
■ TEST CIRCUITS AND WAVEFORMS



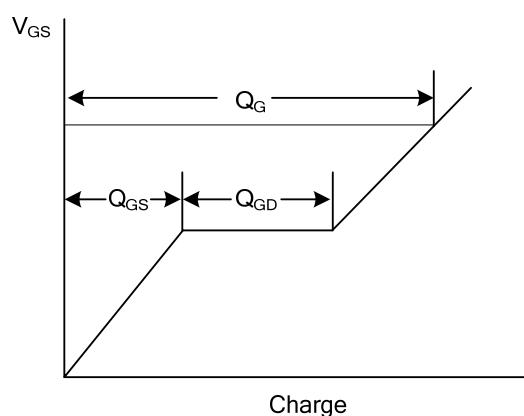
Switching Test Circuit



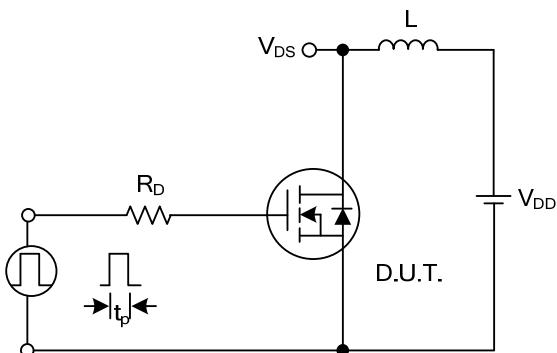
Switching Waveforms



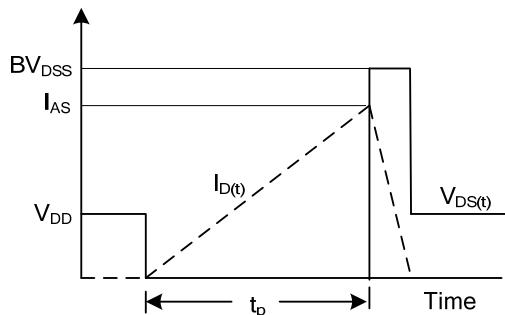
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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